

DATA SHEET



VES1848

Single Chip DAVIC/DVB-RC Cable
Modem

Product specification
File under Integrated Circuits, IC02

1999 Jul 01

Single Chip DAVIC/DVB-RC Cable Modem

VES1848

FEATURES

- Fully compliant ETS300800 and DAVIC 1.2
- Out-Of Band demodulation scheme :
 - On chip 7-bit ADC.
 - DQPSK demodulator.
 - Roll-off factor = 0.3 .
 - Direct IF sampling.
 - Variable bit rate from 1 to 12 Mbit/s (SAW @ 8MHz BW).
 - Automatic Gain Control PWM output.
 - Descrambler.
 - Frame synchronization.
 - Deinterleaver.
 - RS decoder (55,53) .
- In Band scheme :
 - Parallel or serial MPEG2 Transport Stream inputs.
 - MAC PID filtering.
 - DAVIC ATM cells transmission supported.
- Up-Stream synchronization.
- Up-Stream modulation scheme :
 - Burst QPSK/16QAM modulator.
 - Roll-off factor = 0.25/0.3 .
 - Programmable preamble value.
 - Programmable burst length.
 - Direct IF synthesys from 5 to 46 MHz.
 - I and Q base band outputs provided.
 - Variable bit rate from 256kbit/s to 16Mbit/s.
 - Programmable RS encoder.
 - Scrambler.
 - On chip 10 bit DACs.
- External MAC functionality.
- Package 208 MQFP.
- CMOS technology (0.35µm, 3.3V).

APPLICATIONS

- Cable modem.
- DVB interactive set-top box.
- DAVIC ATM cable physical layer.

DESCRIPTION

Based on the DVB-RC cable and DAVIC specifications, the VES 1848 allows interactive communication through HFC network between set-top boxes and headends.

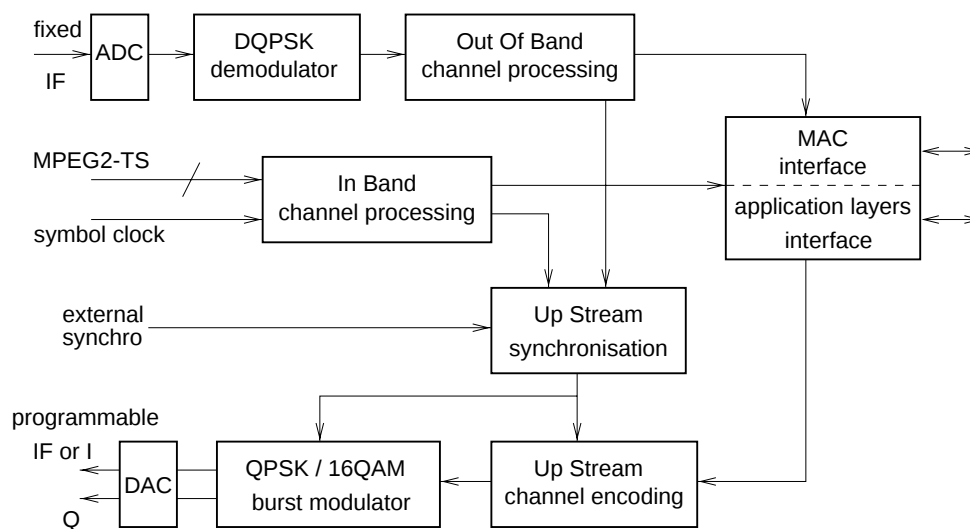
For Down Stream (DS) channel the circuit implements a differential QPSK demodulator (Out Of Band application) and accepts MPEG2 Transport Stream inputs from a DS QAM demodulator (In Band application). This channel allows to synchronize the Up Stream (US) channel and to provide data to the MAC layer which remains external.

The US channel is highly programmable and built around a digital burst QPSK or 16QAM modulator with direct IF synthesys or I and Q base band outputs. The modulator is fully DVB and MCNS compliant thanks to its burst profile programmation (burst length, preamble, RS encoder, scrambler, bit rate ...).

The VES 1848 is packaged in a 208 MQFP, and operates over the commercial temperature 0-70°C.

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1 GENERAL DESCRIPTION**FIGURE 1 : FUNCTIONAL BLOCK DIAGRAM****1.1 ABBREVIATIONS**

AGC	Automatic Gain Control
BW	Bandwidth
CRC	Cyclic Redundancy Checking (type of error correction code)
DS	Down Stream (from the Headend to the set-top box)
HE	Headend
HEC	Header Error Control (CRC of the ATM cell header)
IB	In Band
IF	Intermediate Frequency
NIU	Network Interface Unit (physical and MAC layers of the STB)
OOB	Out Of Band
PWM	Pulse Wave Modulation
SL-ESF	Signalling Link Extended SuperFrame (name of the OOB frame)
STB	Set-Top Box
US	Up Stream (from the set-top box to the headend)
UW	Unique Word (=preamble)

1.2 NOTATION

References to programming registers are done this way :

AD.7 = bit 7 (in decimal) of the register located at the address AD (in hexa).

AD.[7-5] = bits 7 down to 5 of the register located at the address AD.

1.3 FUNCTIONAL DESCRIPTION**➤ ADC**

The VES 1848 implements a 7-bit analog to digital converter. It directly samples the OOB IF signal. The IF value can be chosen by the system designer.

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➤ DQPSK DEMODULATOR

Fully digital variable bitrate demodulator used for the OOB channel. It implements a digital down conversion to base band, filtering and decimation, frequency and clock recoveries as well as equalization. It also provides an AGC command to the OOB tuner.

➤ OOB CHANNEL PROCESSING

After descrambling, deframing and deinterleaving, ATM cells are fed into the RS decoder and corrected. A filtering on ATM headers and MAC headers is then done on valid cells to keep only those addressed to the STB. MAC cells and application layers cells are stored in 2 different FIFOs. Up to 4 different VPI-VCI can be filtered for application layers data.

Mbits and Rxbits⁽¹⁾ are also output after integrity checking.

For US synchronization, 3ms markers are generated.

➤ IB CHANNEL PROCESSING

This block is fed with the outputs of a cable FEC decoder. It implements the filtering of the MAC data addressed to the STB as well as valid time references and valid Rxbits filtering.

Mbits, Rxbits (after integrity checking) and MAC data are stored in a FIFO.

For US synchronization, 3ms markers are generated.

No PID filtering is done for application layers data.

This block implements the filtering of ATM cells transported in MPEG2-TS packet as defined by DAVIC. These data are stored in the application layers FIFO and up to 4 different VPI-VCI can be filtered.

➤ INTERFACES

MAC messages and application layers data are stored in different FIFOs. They can then be read/write with the same or 2 different micro processor interfaces.

The VES 1848 registers are programmed with the MAC interface.

➤ US SYNCHRONIZATION

This block decides when to send an US burst.

When the VES 1848 is used in a DVB/DAVIC device, this block also does the propagation delay compensation and the US slot numbering. It uses information from the DS channel (Mbits, 3ms markers) and some provided by the MAC layer (time compensation, slot number where to send a burst).

When the US path is used in a MCNS device, the burst start information is provided by the toggle of the external synchro pin.

➤ US CHANNEL ENCODING

It is DVB/DAVIC and MCNS compliant thanks to its burst profile programming (6 different profiles can be stored in the VES 1848).

Data read in FIFOs are RS encoded, randomized and differential encoded before the addition of a programmable preamble.

➤ BURST MODULATOR

Data can be output either in base band after predistorsion and nyquist filtering or directly on a programmable IF. In that case a programmable sinewave can also be generated if required.

➤ DAC

Two 10-bit Digital to Analog Converters are built in the VES 1848. The modulated data are provided on both analog and digital outputs.

⁽¹⁾ refer to the DVB or DAVIC specification for the definition of Mbits and Rxbits.

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TABLE 1: ABSOLUTE MAXIMUM RATINGS

Parameter	Min	Max	Unit
Ambient operating temperature : Ta	0	70	°C
DC supply voltage (VDD)	- 0.5	+ 4.1	V
DC Input voltage	- 0.5	VDD + 0.5	V
DC Input Current		± 20	mA
Lead Temperature		+300	°C
Junction Temperature		+150	°C

Stresses above the absolute maximum ratings may cause permanent damage to the device. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

TABLE 2 : RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit	Notes
VDD VD1, VD1IQ	Digital supply voltage	3.14	3.3	3.46	V	3.3V ±5%
VCC	5V supply	4.75	5	5.25	V	5V ± 5%
Ta	Operating temperature	0		70	°C	Ambient temperature
VIH ⁽¹⁾	High-level input voltage	2		VCC + 0.3	V	TTL input
VIL	Low-level input voltage	-0.5		0.8	V	TTL input
VOH ⁽²⁾	High-level output voltage	VDD -0.1 2.4			V	@ IOH = -0.8 mA @ IOH = + 2mA
VOL	Low-level output voltage			0.1 0.4	V	@ IOL = 0.8 mA @ IOL = + 2mA
IDD + ICC	Supply current			300	mA	@US_clk = 116MHz ⁽³⁾
CIN	Input capacitance		15		pF	
COUT	Output capacitance		15		pF	
VD2 VD3, VD4 AVDDI, AVDDQ VD0I, VD0Q	Analog supply voltage	3.14	3.3	3.46	V	3.3V ± 5%
I _{FS}	DAC full scale output current range			25	mA	
R _L	DAC termination resistor			75	ohms	

⁽¹⁾ All inputs are 5V tolerant.

⁽²⁾ IOH, IOL = ± 4mA only for pins DATAA, DATAM, INTA, INTM, VAGC, PWM2, FCONTI, SDAOUT, SDAIN, SCLOUT, WRNA, RDN_ENAA, CSA, US_SACLK.

⁽³⁾ with the US modulator working in continuous mode and with direct IF synthesys.

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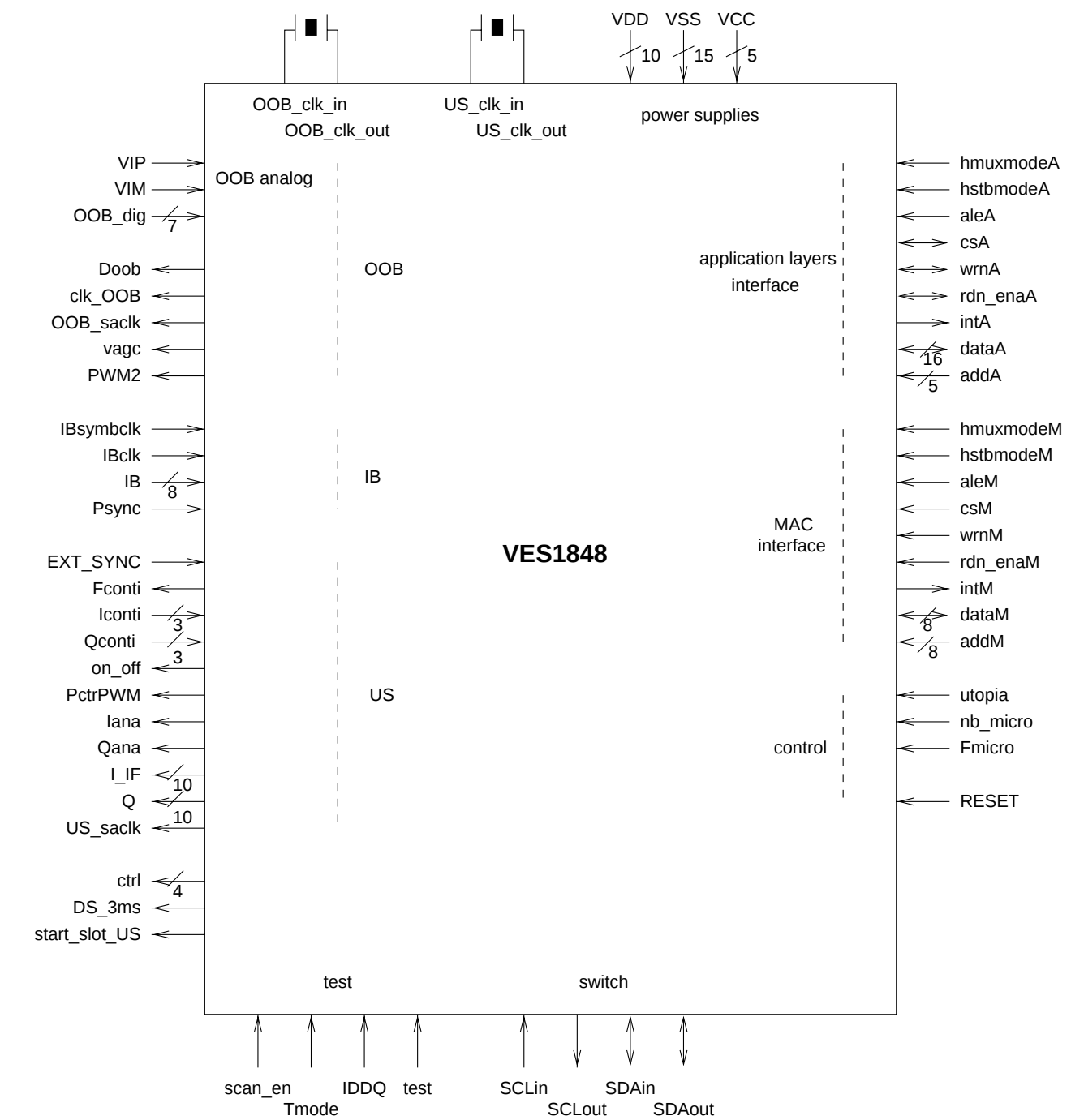
TABLE 3 : ANALOG CHARACTERISTICS

Symbol	Parameter	Min	Typ	Max	Unit	Notes
VIP-VIM	ADC input signal range	-0.5		0.5	V	
ADC Rin	ADC input Resistance	3			kohms	
ADC Cin	ADC capacitance (VIP or VIM)		5	10	pf	
ADC BW	OOB ADC input full power bandwidth	40	50		MHZ	0.1dB bandwidth
I _{FS147}	DAC full scale output current (on Iana and Qana)	17	18	19	mA	VreflQ=1.235V Irefl and irefQ connected to a 147Ω resistor, US_clk = 60MHz
Voc	DAC output voltage compliance	0	1.0	1.05	V	Vout ≤ 1.0V RL ≤ 75 ohms
SFRD	DAC spurious Free Dynamic Range			-50	DBc	RL = 37.5 ohms US_clk = 58 MHz Input data frequency = 0.3 US_clk

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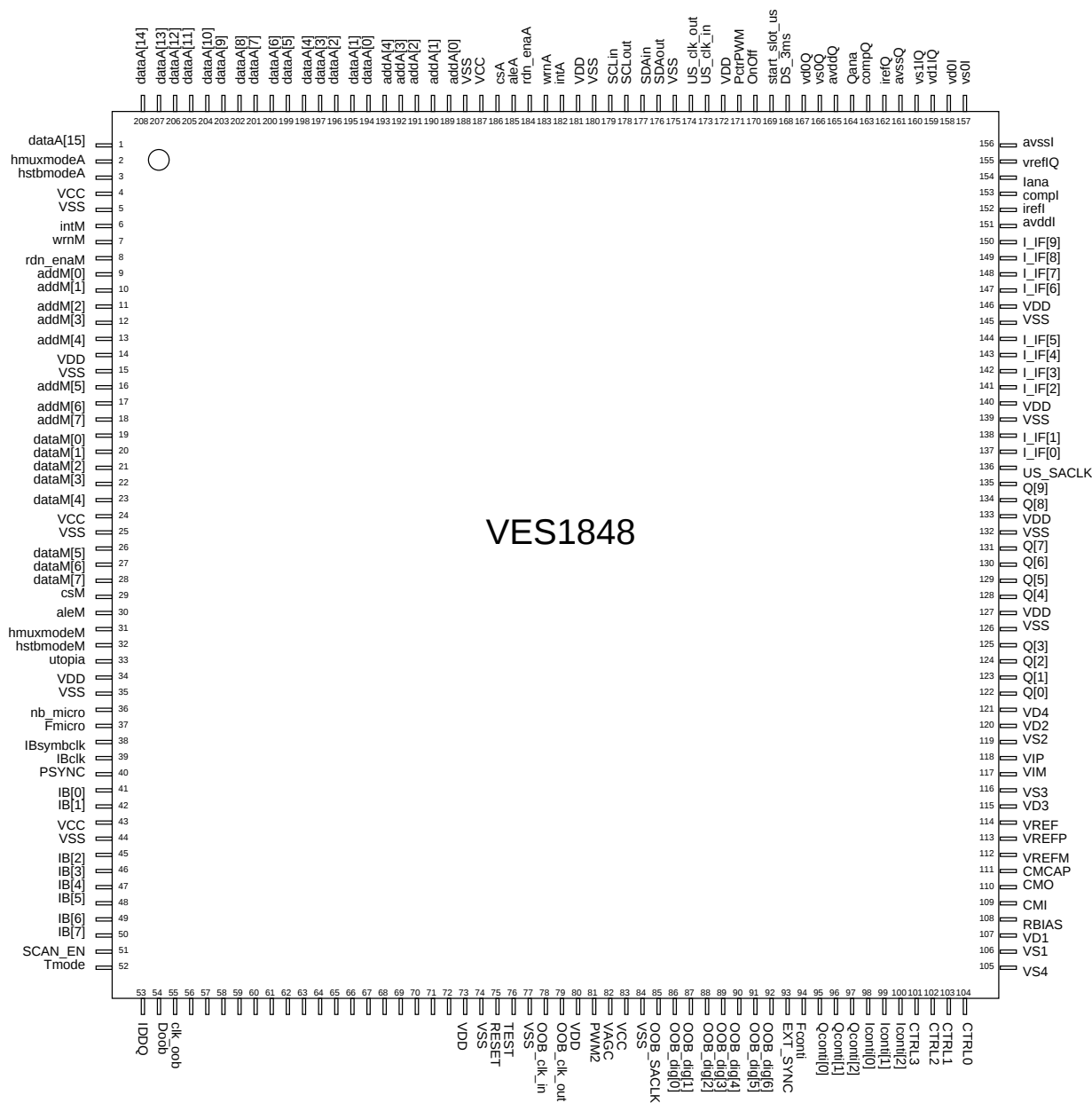
FIGURE 2 : INPUT-OUTPUT BLOCK DIAGRAM



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FIGURE 3 : PIN DIAGRAM



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TABLE 4 : PIN DESCRIPTION

Pin	Pin Name	Direction
1	dataA[15]	I/O
2	hmuxmodeA	I
3	hstbmodeA	I
4	VCC	-
5	VSS	-
6	intM	O
7	wrnM	I
8	rdn_enaM	I
9	addM[0]	I
10	addM[1]	I
11	addM[2]	I
12	addM[3]	I
13	addM[4]	I
14	VDD	-
15	VSS	-
16	addM[5]	I
17	addM[6]	I
18	addM[7]	I
19	dataM[0]	I/O
20	dataM[1]	I/O
21	dataM[2]	I/O
22	dataM[3]	I/O
23	dataM[4]	I/O
24	VCC	-
25	VSS	-
26	dataM[5]	I/O
27	dataM[6]	I/O
28	dataM[7]	I/O
29	csM	I
30	aleM	I
31	hmuxmodeM	I
32	hstbmodeM	I
33	utopia	I
34	VDD	-
35	VSS	-
36	nb_micro	I
37	Fmicro	I
38	IBsymbclk	I
39	IBclk	I
40	PSYNC	I
41	IB[0]	I
42	IB[1]	I

Pin	Pin Name	Direction
43	VCC	-
44	VSS	-
45	IB[2]	I
46	IB[3]	I
47	IB[4]	I
48	IB[5]	I
49	IB[6]	I
50	IB[7]	I
51	SCAN_EN	I
52	Tmode	I
53	IDDQ	I
54	Doob	O
55	clk_oob	O
56	Not used	-
57	Not used	-
58	Not used	-
59	Not used	-
60	Not used	-
61	Not used	-
62	Not used	-
63	Not used	-
64	Not used	-
65	Not used	-
66	Not used	-
67	Not used	-
68	Not used	-
69	Not used	-
70	Not used	-
71	Not used	-
72	Not used	-
73	VDD	-
74	VSS	-
75	RESET	I
76	TEST	I
77	VSS	-
78	OOB_clk_in	I
79	OOB_clk_out	O
80	VDD	-
81	PWM2	O
82	VAGC	O
83	VCC	-
84	VSS	-

Pin	Pin Name	Direction
85	OOB_SACLK	O
86	OOB_dig[0]	I
87	OOB_dig[1]	I
88	OOB_dig[2]	I
89	OOB_dig[3]	I
90	OOB_dig[4]	I
91	OOB_dig[5]	I
92	OOB_dig[6]	I
93	EXT_SYNC	I
94	Fconti	O
95	Qconti[0]	I
96	Qconti[1]	I
97	Qconti[2]	I
98	Iconti[0]	I
99	Iconti[1]	I
100	Iconti[2]	I
101	CTRL3	O
102	CTRL2	O
103	CTRL1	O
104	CTRL0	O
105	VS4	-
106	VS1	-
107	VD1	-
108	RBIAS	I
109	CMI	O
110	CMO	O
111	CMCAP	I
112	VREFM	O
113	VREFP	O
114	VREF	O
115	VD3	-
116	VS3	-
117	VIM	I
118	VIP	I
119	VS2	-
120	VD2	-
121	VD4	-
122	Q[0]	O
123	Q[1]	O
124	Q[2]	O
125	Q[3]	O
126	VSS	-

Pins 56 to 72 as well as all input pins not used must be grounded.

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127	VDD	-
128	Q[4]	O
129	Q[5]	O
130	Q[6]	O
131	Q[7]	O
132	VSS	-
133	VDD	-
134	Q[8]	O
135	Q[9]	O
136	US_SACLK	O
137	I_IF[0]	O
138	I_IF[1]	O
139	VSS	-
140	VDD	-
141	I_IF[2]	O
142	I_IF[3]	O
143	I_IF[4]	O
144	I_IF[5]	O
145	VSS	-
146	VDD	-
147	I_IF[6]	O
148	I_IF[7]	O
149	I_IF[8]	O
150	I_IF[9]	O
151	avddl	-
152	irefl	I
153	compl	I

154	lana	O
155	vreflQ	I
156	avssl	-
157	vs0I	-
158	vd0I	-
159	vd1IQ	-
160	vs1IQ	-
161	avssQ	-
162	irefQ	I
163	compQ	I
164	Qana	O
165	avddQ	-
166	vs0Q	-
167	vd0Q	-
168	DS_3ms	O
169	start_slot_us	O
170	OnOff	O
171	PctrPWM	O
172	VDD	-
173	US_clk_in	I
174	US_clk_out	O
175	VSS	-
176	SDAout	I/O
177	SDAin	I/O
178	SCLout	O
179	SCLin	I
180	VSS	-

181	VDD	-
182	intA	O
183	wrnA	I/O
184	rdn_enaA	I/O
185	aleA	I
186	csA	I/O
187	VCC	-
188	VSS	-
189	addA[0]	I
190	addA[1]	I
191	addA[2]	I
192	addA[3]	I
193	addA[4]	I
194	dataA[0]	I/O
195	dataA[1]	I/O
196	dataA[2]	I/O
197	dataA[3]	I/O
198	dataA[4]	I/O
199	dataA[5]	I/O
200	dataA[6]	I/O
201	dataA[7]	I/O
202	dataA[8]	I/O
203	dataA[9]	I/O
204	dataA[10]	I/O
205	dataA[11]	I/O
206	dataA[12]	I/O
207	dataA[13]	I/O
208	dataA[14]	I/O

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2 INPUT - OUTPUT SIGNAL DESCRIPTION

SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
US_clk_in	173	I	XTAL oscillator input pin. Typically a fifth overtone XTAL oscillator is connected between the US_clk_in and US_clk_out pins.
US_clk_out	174	O	XTAL oscillator output pin. Typically a fifth overtone XTAL oscillator is connected between the US_clk_in and US_clk_out pins.
OOB_clk_in	78	I	XTAL oscillator input pin. Typically a fifth overtone XTAL oscillator is connected between the OOB_clk_in and OOB_clk_out pins.
OOB_clk_out	79	O	XTAL oscillator output pin. Typically a fifth overtone XTAL oscillator is connected between the OOB_clk_in and OOB_clk_out pins.
OOB_dig[6:0]	86,87,88,89 90,91,92	I	IF digital OOB signal. OOB_dig[6:0] is connected to an external A/D converter. OOB_dig[6] is the MSB. When not used, OOB_dig[6:0] must be tied to ground.
OOB_sack	85	O (5V)	IF OOB Sampling Clock. Can be used as the sampling clock of an external 7-bit ADC that will generate OOB_dig signals.
Doob	54	O (5V)	Output of the OOB DQPSK demodulator. Data are output on the falling edge of clk_oob.
clk_oob	55	O (5V)	Bit clock associated with Doob.
VAGC	82	O (5V)	PWM encoded output signal for AGC. This signal is typically fed to the AGC amplifier through a single RC network.
PWM2	81	O (5V)	PWM encoded programmable signal. The encoded data is the parameter PWM2 (C2[7:0]). This signal can be used to control a second input of the AGC amplifier through a single RC network.
IBsymbclk	38	I	IB symbol clock. This clock is provided by the QAM demodulator. Its polarity can be selected with parameter PsymblB(AE.3).
IBclk	39	I	IB byte clock associated with the data bus IB[7:0]. Its polarity can be selected with parameter PbyteIB(AE.2).
IB[7:0]	41,42,45,46 47,48,49,50	I	IB MPEG2-TS input. These 8-bit parallel data are the outputs of the DS QAM FEC. When the parallel interface is selected (Parameter serie = 0, address 82.6) then IB[7:0] is the transport stream input (IB[7] is the MSB). When the serial interface is selected (Parameter serie = 1, address 82.6) then the serial input is on pin IB[0] (pin 41).
PSYNC	40	I	If parameter Ps_DE=0 (address 83.7) : Pulse SYNChro. This input signal must be high when the sync byte (47 ₁₆) is provided on IB[7:0], then it must be low until the next sync byte. If the serial interface is selected, then PSYNC is high only during the first bit of the sync byte (47 ₁₆). If parameter Ps_DE=1 (address 83.7) : data enable. This input signal must be high during the first 188 bytes of the MPEG2-TS packet. It is then low during the redundancy bytes.
EXT_SYNC	93	I	EXTErnal SYNChro. Only used when parameter InExt=1 (88.1). When not used, must be tied to ground. This input signal toggles at each US burst start. EXT_SYNC must be initiated to 0.
Fconti	94	O (5V)	Programmable clock with the parameter contiCk (AF.[5-4]). This clock must be used in continuous mode to generate lconti[2:0] and Qconti[2:0].
lconti[2:0]	98,99,100	I	I input for the US modulator in continuous mode (parameter contiMode=1 (AF.3), and contiMem=0 (AF.6)). This data bus is clocked on the rising edge of Fconti clock.

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SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
Qconti[2:0]	95,96,97	I	Q input for the US modulator in continuous mode (parameter contiMode=1 (AF.3), and contiMem=0 (AF.6)). This data bus is clocked on the rising edge of Fconti clock.
OnOff	170	O (5V)	On/off command for the US amplifier. It can be active high or low depending on parameter Pampli (AE.6). It is activated just before the start of a burst and deactivated just after the end of the burst.
PctrPWM	171	O (5V)	PWM encoded output signal to control the US amplifier power level. The encoded data is the parameter PwAmpli (95.[7-0]). This signal is typically fed to the US amplifier through a single RC.
I_IF[9:0]	137,138,141,142 143,144,147,148 149,150	O (3.3V)	When parameter BB_IF=0 (AD.2) : I base band digital output. When parameter BB_IF=1 (AD.2) : modulated IF digital output. I_IF[9] is the MSB. I_IF is in offset binary.
Q[9:0]	122,123,124,125 128,129,130,131 134,135	O (3.3V)	When parameter BB_IF=0 (AD.2) : Q base band digital output. When parameter BB_IF=1 (AD.2) : programmable sinewave (B0.[7-0], B1.[7-0]) digital output. Q[9] is the MSB. Q is in offset binary.
US_SACLK	136	O (3.3V)	US Sampling Clock for the external DACs connected to I_IF and Q.
CTRL[3:0]	101,102,103,104	O (5V)	Control pins. Their values are programmable through regCtrl[5:2] (FE.[5-2]). RegCtrl[5] controls CTRL[3] (pin 101). CTRL are open drain outputs and therefore require external pull up resistors to VCC.
DS_3ms	168	O (5V)	3ms markers received DS either IB or OOB. Mainly used for test. Active high pulse that is one US_clk period long.
start_slot_us	169	O (5V)	Start of US slot as defined in the DVB/DAVIC spec. Mainly used for test. Active high pulse that is one US_clk period long.
SCAN_EN	51	I	For normal operation of the VES 1848, SCAN_EN must be grounded.
Tmode	52	I	For normal operation of the VES 1848, Tmode must be grounded.
IDDQ	53	I	For normal operation of the VES 1848, IDDQ must be grounded.
TEST	76	I	For normal operation of the VES 1848, TEST must be grounded.
SCLin	179	I	The VES1848 is only a switch between SCLin and SCLout. It is used to isolate the OOB tuner (programmed by I2C) from the I2C bus. When regCtrl[0]=0 (FE.0) SCLout is isolated from SCLin.
SCLout	178	O (5V)	The VES1848 is only a switch between SCLin and SCLout. It is used to isolate the OOB tuner (programmed by I2C) from the I2C bus. When regCtrl[0]=0 (FE.0) SCLout is isolated from SCLin.
SDAin	177	I/O (5V)	The VES1848 is only a switch between SDAin and SDAout. It is used to isolate the OOB tuner (programmed by I2C) from the I2C bus. When regCtrl[0]=0 (FE.0) SDAout is isolated from SDAin. SDA is a bidirectional signal. When regCtrl[1]=0 (FE.1) SDAin is an input else it is an output.
SDAout	176	I/O (5V)	The VES1848 is only a switch between SDAin and SDAout. It is used to isolate the OOB tuner (programmed by I2C) from the I2C bus. When regCtrl[0]=0 (FE.0) SDAout is isolated from SDAin. SDA is a bidirectional signal. When regCtrl[1]=1 (FE.1) SDAout is an input else it is an output.

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SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
RESET	75	I	The RESET input is asynchronous, active low, and clears the VES 1848. When RESET goes low, the circuit immediately enters its reset mode and normal operation will resume 4 OOB_clk falling edges or 8 US_clk falling edges or 4 IBclk falling edges (depending which delay is the bigger) later after RESET returned high. The register contents are all initialized to their default values. The minimum width of RESET at low level is the maximum of 4 OOB_clk clock periods, 8 US_clk clock periods and 4 IBclk clock periods.
Fmicro	37	I	Controls the working frequency of the interface block. If Fsysus > 65MHz then Fmicro must be set to Vdd. If Fsysus ≤ 65MHz then Fmicro must be set to Vss.
nb_micro	36	I	If a single micro-processor is used to read the MAC data and the application layers data then nb_micro must be set to Vdd. If the application layers data are read by an other circuit then nb_micro must be set to Vss.
utopia	33	I	Must be set to Vss. Application layers data can only be read through a micro processor interface.
AddM[7:0]	9,10,11,12 13,16,17,18	I	MAC interface address bus. AddM[7] is the MSB.
DataM[7:0]	19,20,21,22 23,26,27,28	I/O (5V)	MAC interface data bus. DataM[7] is the MSB.
IntM	6	O (5V)	MAC interface active low interrupt line. IntM is an open drain output and therefore requires an external pull up resistor to VCC.
hstbmodeM	32	I	Host interface STRobe mode (Intel=0, Motorola=1) for the MAC interface.
hmuxmodeM	31	I	Host interface MUX mode for the MAC interface : address and data multiplexed (=1) or not (=0).
rdn_enaM	8	I	MAC interface active low read strobe (Intel mode) or active low data valid (Motorola mode).
wrnM	7	I	MAC interface active low write strobe (Intel mode) or read(=1) /write(=0) qualifier (Motorola mode).
csM	29	I	MAC interface active low Chip Select.
aleM	30	I	MAC interface Address Latch Enable (only for multiplexed micro-processor).
addA[4:0]	189,190,191 192,193	I	Application layers interface address bus. addA[4] is the MSB.
dataA[15:0]	194,195,196,197 198,199,200,201 202,203,204,205 206,207,208,1	I/O (5V)	Application layers interface data bus. dataA[15] is the MSB.
IntA	182	O (5V)	Application layers interface active low interrupt line. IntA is an open drain output and therefore requires an external pull up resistor to VCC.
hstbmodeA	3	I	Host interface STRobe mode (Intel=0, Motorola=1) for the application layers interface.
hmuxmodeA	2	I	Host interface MUX mode for the application layers interface : address and data multiplexed (=1) or not (=0).
rdn_enaA	184	I	application layers interface active low read strobe (Intel mode) or active low data valid (Motorola mode).
wrnA	183	I	application layers interface active low write strobe (Intel mode) or read(=1) /write(=0) qualifier (Motorola mode).
csA	186	I	application layers interface active low Chip Select.

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SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
aleA	185	I	application layers interface Address Latch Enable (only for multiplexed micro-processor).
VIP	118	I	IF analog OOB input signal. Positive input to the A/D converter. This pin is DC biased to half-supply through an internal resistor divider (2 x 10kΩ resistors). In order to remain in the range of the ADC, the voltage difference between pins VIP and VIM should be between -0.5 and 0.5 volts.
VIM	117	I	IF analog OOB input signal. Negative input to the A/D converter. This pin is DC biased to half-supply through an internal resistor divider (2 x 10kΩ resistors). In order to remain in the range of the ADC, the voltage difference between pins VIP and VIM should be between -0.5 and 0.5 volts.
CMCAP	111	I	This pin is connected to a tap point on an internal resistor divider used to create CMO and CMI. An external capacitor of value .1 μf should be connected between this point and ground to provide good power supply rejection from the positive supply at higher frequencies.
RBIAS	108	I	An external resistor of value 3.3kΩ should be connected between this pin and ground to provide good accurate bias currents for the analog circuits on the ADC.
VREF	114	O	This is the output of an on-chip resistor divider. An external capacitor of value .1μf should be connected between this point and ground to provide good power supply rejection from the positive supply at higher frequencies. Reference voltages VREFP and VREFM are derived from the voltage on VREF.
VREFP	113	O	This is a positive voltage reference for the A/D converter. It is derived from the voltage on pin VREF through an on-chip fully-differential amplifier. The voltage on this pin is nominally equal to CMO + 0.25 volts.
VREFM	112	O	This is the negative voltage reference for the A/D converter. It is derived from the voltage on pin VREF through an on-chip fully-differential amplifier. The voltage on this pin is nominally equal to CMO - 0.25 volts.
CMO	110	O	This pin provides the common-mode out voltage for the analog circuits on the ADC. It is the buffered version of a voltage derived from an on-chip resistor divider, and has a nominal value of 0.5 x VD3.
CMI	109	O	This pin provides the common-mode in voltage for the analog circuits on the ADC. It is the buffered version of a voltage derived from an on-chip resistor divider, and has a nominal value of 0.75 x VD3.
VD1	107	I	Power supply input for the digital switching circuitry (3.3V typ).
VS1	106	I	Ground return for the digital switching circuitry.
VD2	120	I	Power supply input for the analog clock drivers (3.3V typ).
VS2	119	I	Ground return for the analog clock drivers.
VD3	115	I	Power supply input for the analog circuits (3.3V typ).
VS3	116	I	Ground return for analog circuits.
VD4	121	I	Power supply input connected to an n-well guard ring that surrounds the ADC (3.3V typ).
VS4	105	I	Ground for a p+ guard ring that surrounds the ADC.

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SYMBOL	PIN NUMBER	TYPE	DESCRIPTION
Iana	154	O	Analog output current for channel I. Iana is the output of the DAC and can directly drive a single or double terminated 75Ω transmission line. When parameter BB_IF=0 (AD.2) : I base band analog output. When parameter BB_IF=1 (AD.2) : modulated IF analog output.
Qana	164	O	Analog output current for channel Q. Qana is the output of the DAC and can directly drive a single or double terminated 75Ω transmission line. When parameter BB_IF=0 (AD.2) : Q base band analog output. When parameter BB_IF=1 (AD.2) : programmable sinewave (B0.[7-0], B1.[7-0]) analog output.
Compl	153	I	An external .1μF bypass capacitor must be connected between this pin and analog VDD to stabilize the internal current reference node of the D/A converter of channel I.
CompQ	163	I	An external .1μF bypass capacitor must be connected between this pin and analog VDD to stabilize the internal current reference node of the D/A converter of channel Q.
IrefI	152	I	An external resistor of value 147Ω should be connected between this pin and ground to provide good accurate bias currents for the analog circuits on the DAC of channel I.
IrefQ	162	I	An external resistor of value 147Ω should be connected between this pin and ground to provide good accurate bias currents for the analog circuits on the DAC of channel Q.
VrefIQ	155	I	Voltage reference of 1.235V for both DAC.
AVDDI	151	I	DAC analog core power supply (3.3V)
AVSSI	156	I	DAC analog core ground.
VS0I	157	I	Ground for a P+ guard ring that surrounds the DAC (must be a clean Vss)
VD0I	158	I	Power supply for an N- guard ring that surrounds the DAC (must be a clean 3.3V)
VD1IQ	159	I	DAC digital core power supply (3.3V)
VS1IQ	160	I	DAC digital core ground.
AVSSQ	161	I	DAC analog core ground.
AVDDQ	165	I	DAC analog core power supply (3.3V)
VS0Q	166	I	Ground for a P+ guard ring that surrounds the DAC (must be a clean Vss).
VD0Q	167	I	Power supply for an N- guard ring that surrounds the DAC (must be a clean 3.3V).

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FIGURE 4 : APPLICATION EXAMPLE 1

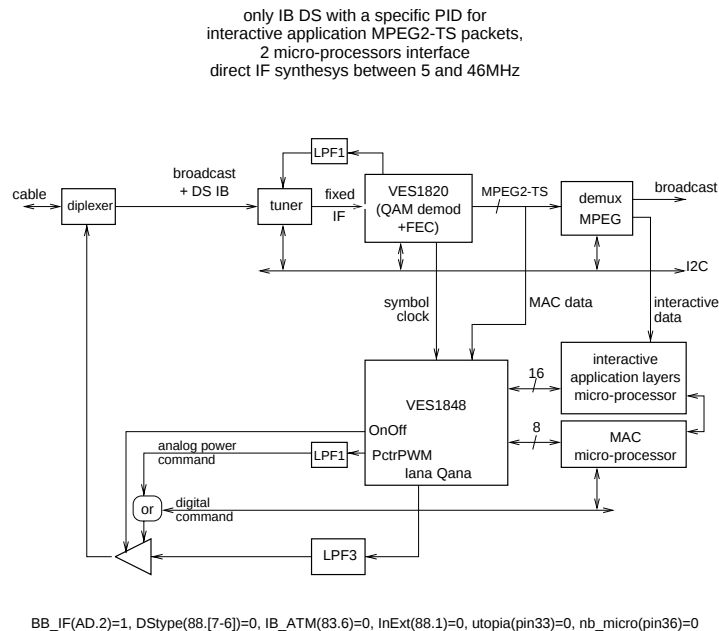
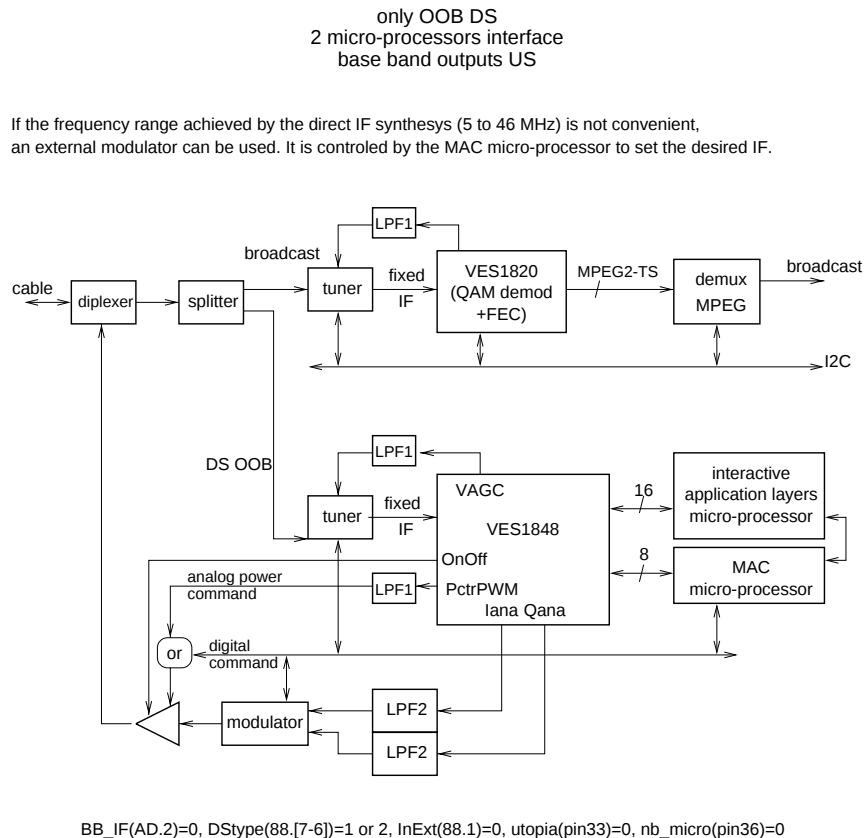


FIGURE 5 : APPLICATION EXAMPLE 2



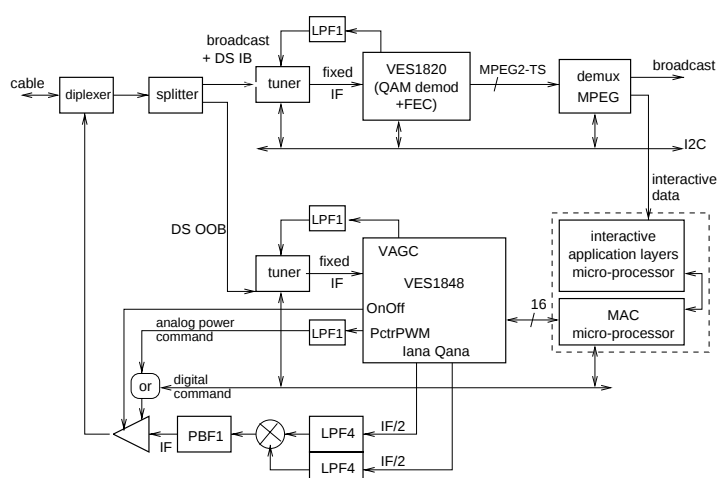
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FIGURE 6 : APPLICATION EXAMPLE 3

OOB (MAC and application data) and
IB (application data with a specific PID)
1 micro-processor interface
IF between 5 and 65MHz

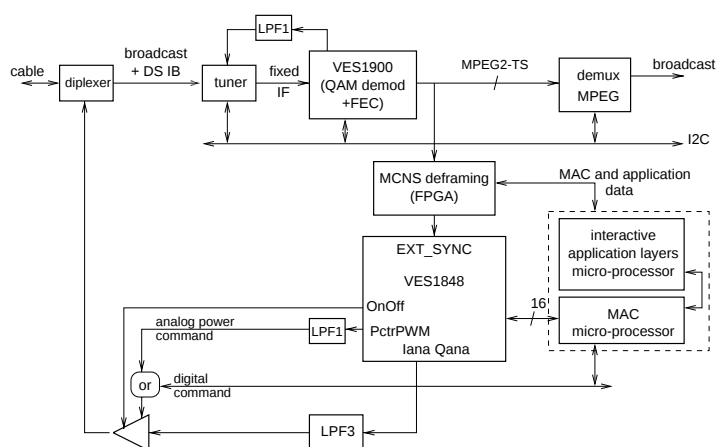
An other solution to get an US frequency band larger than the direct IF synthesys range is to use the sinewave generated on Q and mixed it with the modulated signal (output on I).
The carrier frequency on I and the sinewave frequency on Q are chosen equal to $IF/2$.
Thus after multiplication we get one spectrum centered on the IF frequency and the second centered on 0.



BB IF(AD.2)=1, DStype(88.[7-6])=1 or 2, IB ATM(83.6)=0, InExt(88.1)=0, utopia(pin33)=0, nb_micro(pin36)=1

FIGURE 7 : APPLICATION EXAMPLE 4

DS MCNS
single micro-processor interface
direct IF synthesys between 5 and 46MHz



BB IF(AD.2)=1, InExt(88.1)=1, utopia(pin33)=0, nb_micro(pin36)=1

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DATA SHEET STATUS	PRODUCT STATUS	DEFINITIONS ⁽¹⁾
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